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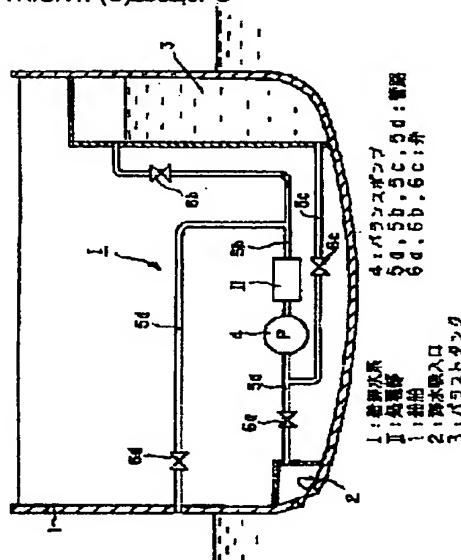
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(54) TREATING METHOD FOR SHIP BALLAST WATER COPYRIGHT: (C)2002,JPO  
AND ITS TREATING APPARATUS

(57) Abstract:

PROBLEM TO BE SOLVED: To provide a treating apparatus for ship ballast water, which does not obstruct navigation by the treating work and renders prescribed harmful microorganisms harmless efficiently with small motive energy.

SOLUTION: A ballast water treating part II is installed in the middle of a pipe line 5 in a water supply/discharge system 1 to render harmful microorganisms harmless, which exist in ballast water introduced into a ballast tank 3 or in ballast water discharged from the ballast tank 3. The treating part II has electrodes that face the ballast water and apply a high-voltage pulse to it. The harmful organisms are damaged and defused by directly applying high voltage to them and therefore causing electric discharge in them, or they are damaged and defused indirectly by the energy of shock waves that are produced by arc discharge generated when the high-voltage pulse is applied across the electrodes.



PN JP2002192161 A 20020710  
 TI TREATING METHOD FOR SHIP BALLAST WATER AND ITS  
 TREATING APPARATUS

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ICO M02F103/00S; M02F201/48D2  
 FI B63B13/00&Z; C02F1/48&B  
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 AP JP20000394857 20001226  
 PR JP20000394857 20001226  
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AN 2003-078582 [08]  
 TI Ballast water processing in vessels, involves applying high voltage between electrodes placed in ballast water flow path

AB JP2002192161 NOVELTY - A high voltage is applied between electrodes placed in a ballast water flow path.

USE - For ballast water processing in vessels, e.g. tankers in harbors.

ADVANTAGE - Harmless and harmful microorganisms in the ballast water are destroyed efficiently.

DESCRIPTION OF DRAWING(S) - The figure shows a sectional view of the ballast water processing apparatus. (Drawing includes non-English language text).

(Dwg.1/19)

IW BALLAST WATER PROCESS VESSEL APPLY HIGH  
 VOLTAGE ELECTRODE PLACE BALLAST WATER FLOW PATH  
 PN JP2002192161 A 20020710 DW200308 C02F1/48 023pp  
 IC B63B13/00 ;C02F1/48  
 MC H03-D H03-E  
 W06-C07 X25-H03  
 DC H03 Q24 W06 X25  
 PA (MITO) MITSUBISHI JUKOGYO KK  
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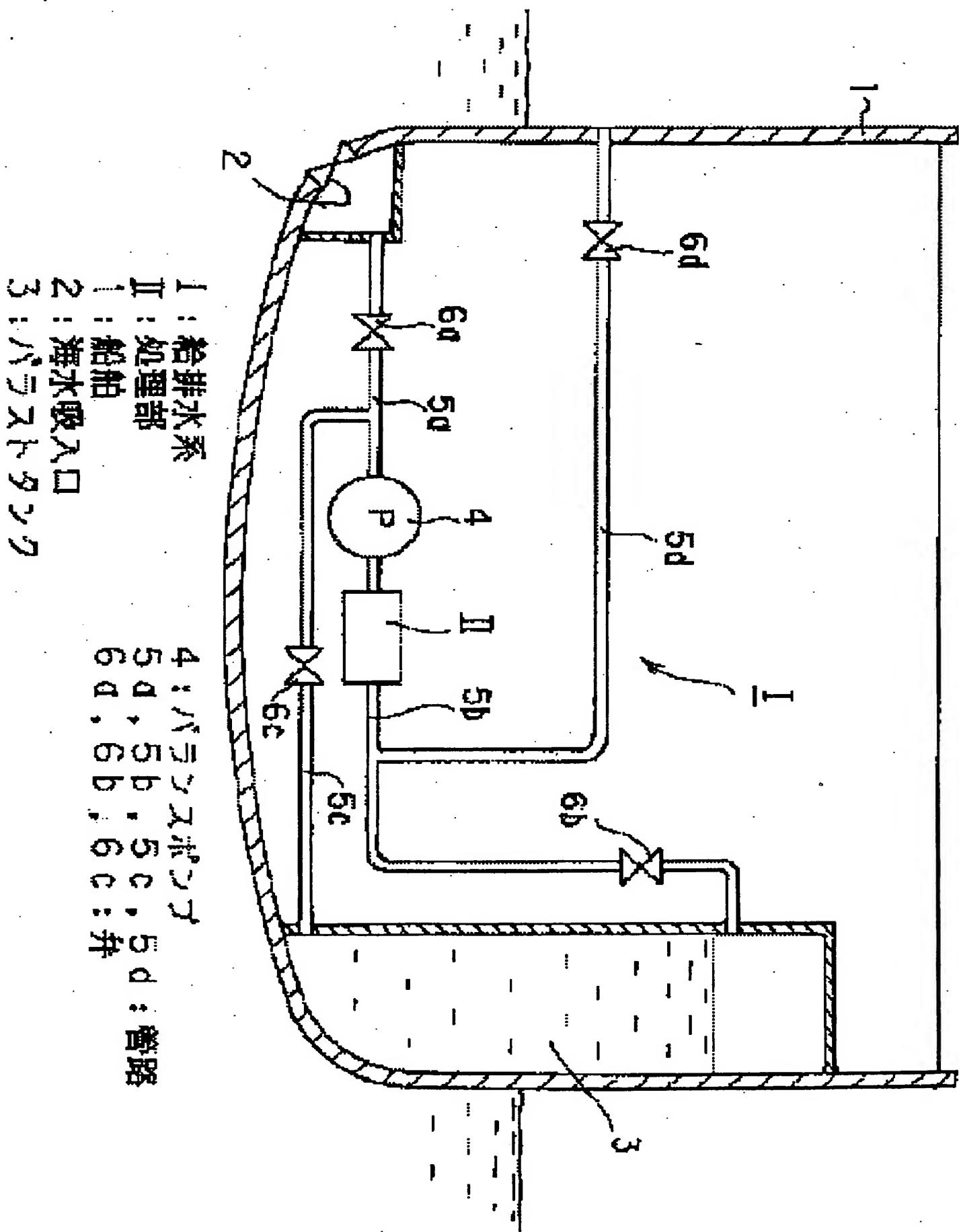
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